



## AGB75LC04-XX-X – Electrical and Environmental Specifications:

208 pin: AGB75LC04-QU-E / 225 pin: AGB75LC04-BG-E

<b>Recommended Operating Conditions</b>	
Power supply $V_{cc}$	3.0V to 3.6V, 3.3V nominal
Power supply $V_{core}$	1.08V to 1.32V, 1.2V nominal
<b>Environmental Specifications</b>	
Operating temperature	-40°C to +85°C
Storage temperature	-60°C to +150°C
<b>DC Specifications</b>	
$V_{core}$ Supply current	22mA @ 1.2V
<b>RoHS Compliant Package Options</b>	
208-PQFP	28x28x3.4mm, 0.5 mm pin pitch
225-ball LFBGA	13x13x1.4mm, 0.8 mm ball pitch

The advanced power management controller has a very slow clock operating mode and software programmable power optimization capabilities. Along with a reset controller and shutdown controller, this gives the AGB75LC04-XX-X several low-power options.

The accelerated graphic memory architecture allows for concurrent access to 3 individual memory subsystems for simultaneous program execution, LCD refresh, and frame buffer rendering.

### System Parameters:

LCDs supported	Up to 12" active (TFT) or passive and 24-bit color
Interfaces supported	USB, UART, TWI and SPI
Number of GPIO	39 Dedicated pins on the LFBGA and up to 17 on the PQFP package
Integrated Touch Panel Decoder	4- or 5-wire, calibration, noise filtering
SDRAM	32-bit parallel interface
Flash	AT45 Series Data Flash or Compatible Serial Data Flash Recommended

